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A Leading Logic NVM Company

November, 2015

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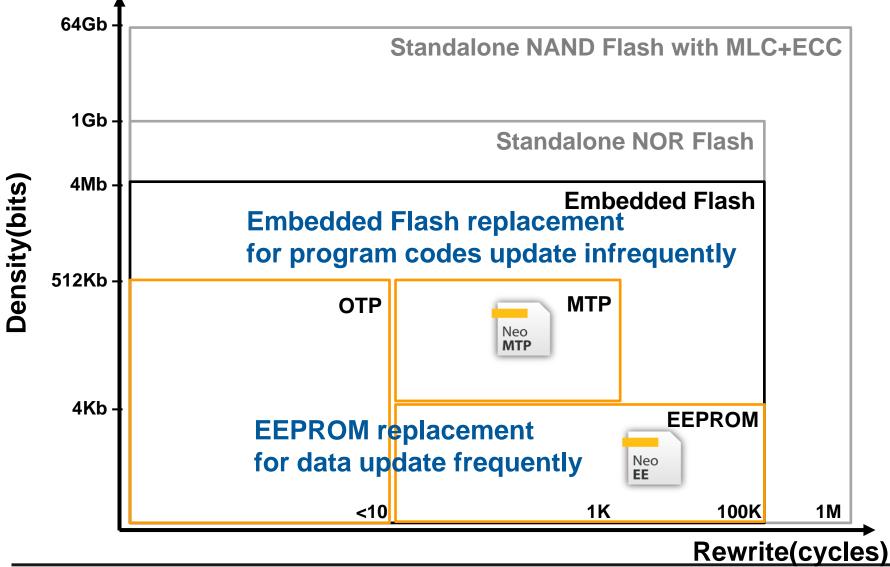
Outline

Business Model

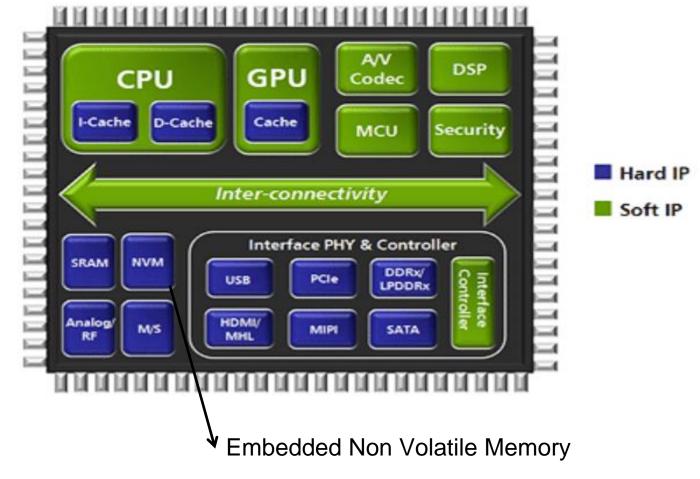
- Review of Operations
- Growth Opportunity and Future Outlook
- Q & A



Nonvolatile Memory Classifications



SOC Block Diagram



Source : tsmc



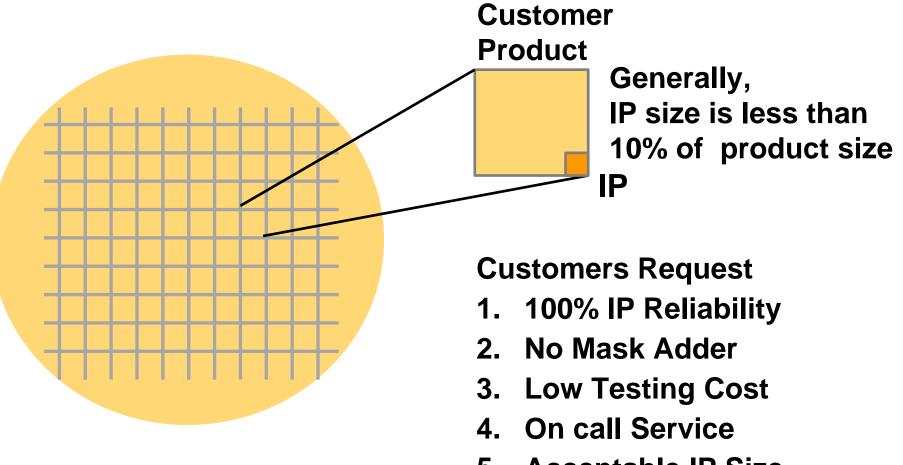
Embedded NVM Technologies

	ROM	eFuse (OTP)	Antifuse (OTP)	CMOS Floating Gate (OTP)	CMOS Floating Gate (MTP)	Embedded Flash
Cell Structure	Transistor	Poly Fuse	Antifuse	Floating Gate	Floating Gate	Floating Gate
Standard CMOS Compatible	Yes	Yes	Yes	Yes	Yes	No
Bitcell Area	< 1	50	1	2	4	1
Endurance	Νο	No	< 10	< 10	10K-100K	100-1000K
Density	4Kb-1Mb	256bit-4Kb	16bit-1Mb	16Kb-1Mb	1Kb-2M	64Kb-4Mb
Security	Low	Low	High	High	High	High
Additional Steps	None	None	None	None	None	+10 Mask

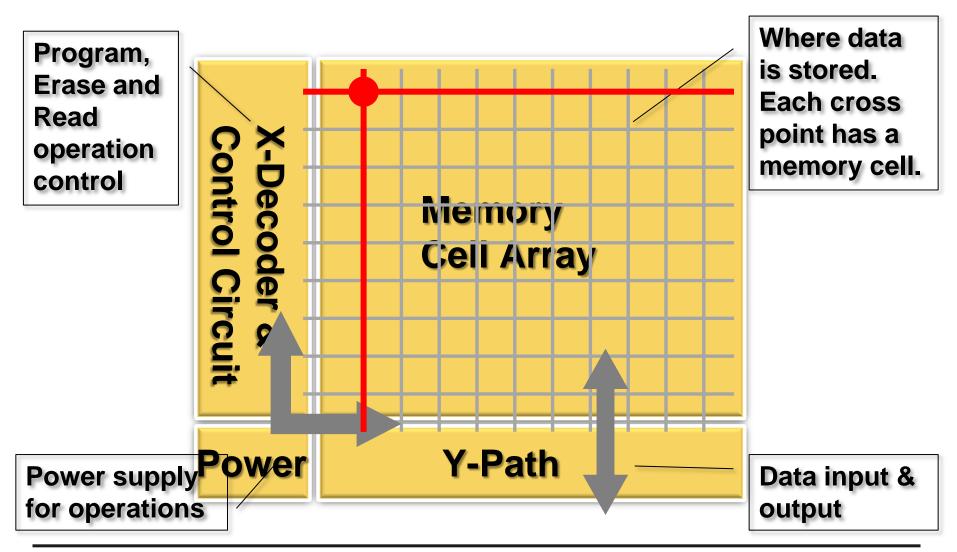
•ROM not programmable, eFuse cannot scale beyond 16Kb, embedded flash expensive and cannot scale after 40 nm

•eMemory's IPs: OTP (antifuse, floating gate) and MTP (floating gate)

Considerations for IP Adoption

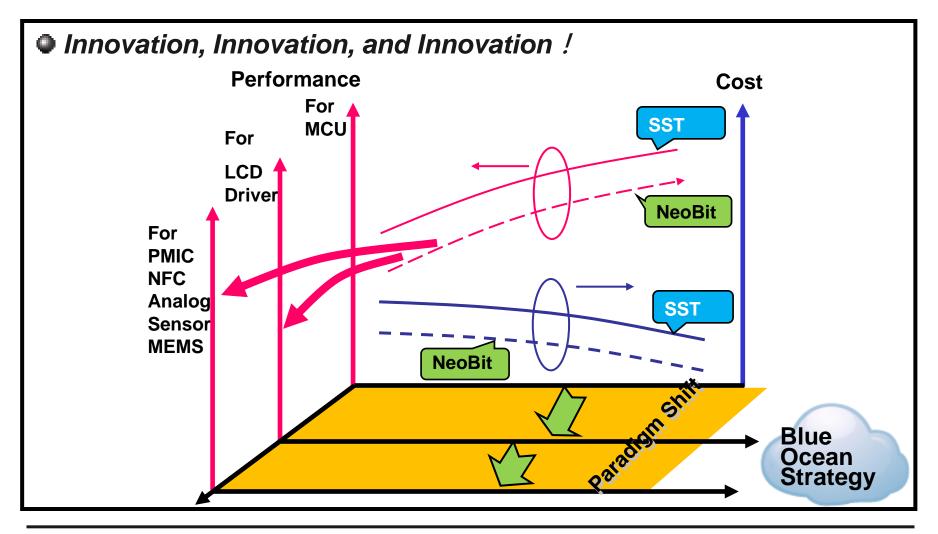


Inside Nonvolatile Memory IP



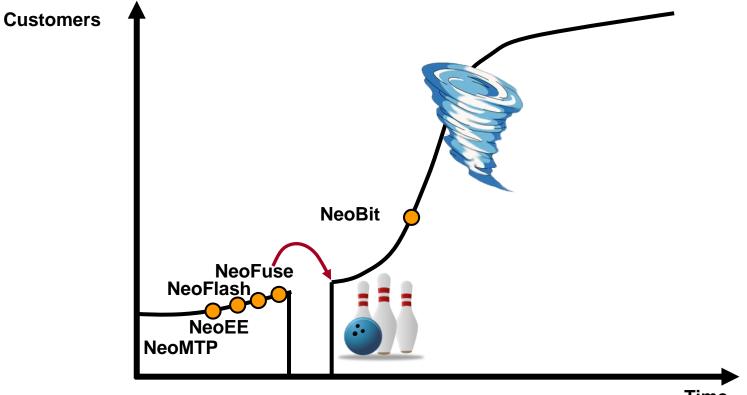
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What We Have Done



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Crossing the Chasm



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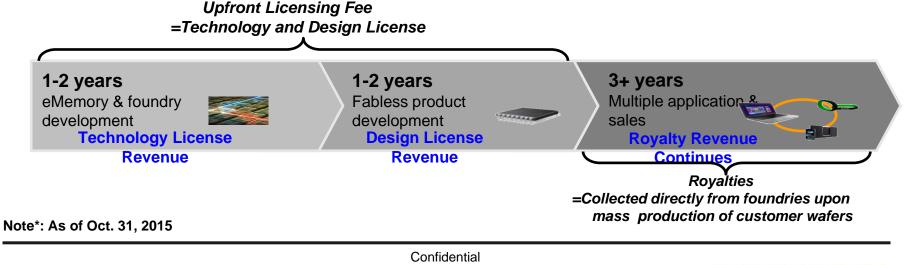


Business Model

- Founded in 2000. First customer engaged in 2002. Achieved profitability in 2005 and IPO in 2011. The largest logic non-volatile memory IP company, 224 employees (155 R&D)*.
- Since its IPO, the company initiated no new fund raising or bank debt, and has distributed in excess of 100% of earnings in cash dividends.
- Growth Indices: 1) No. of on-going technology platforms

2) No. of design licenses

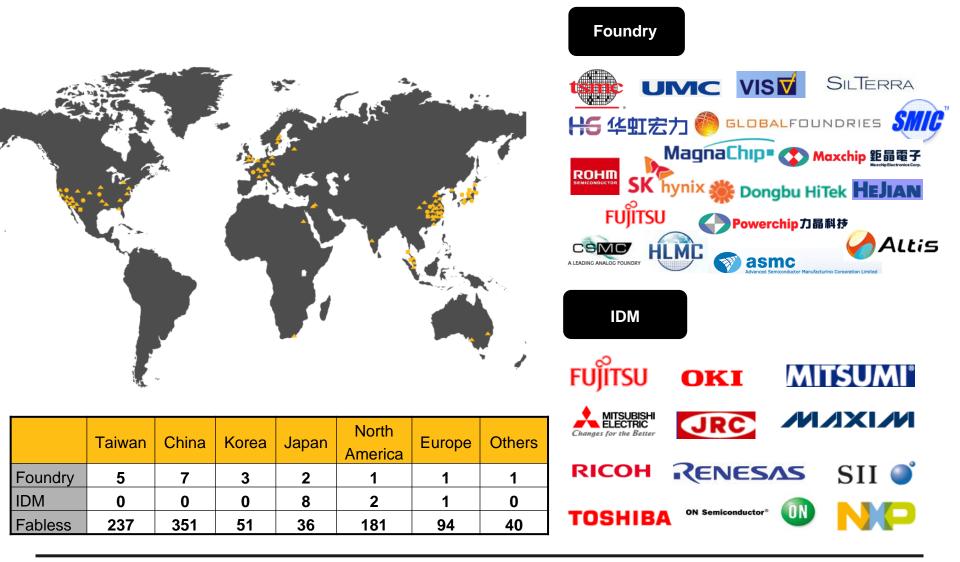
3) Royalty



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Worldwide Customers

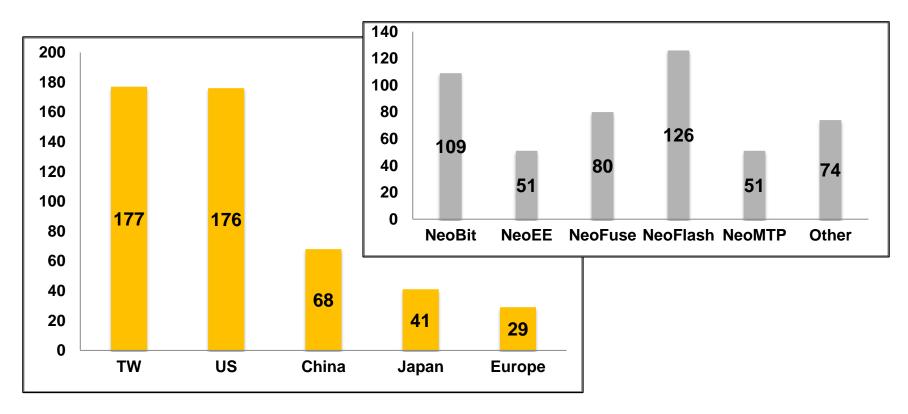


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Patent Portfolio

	Q215	Q315	Diff.
Pending	181	187	+6
Issued	287	304	+17
Total	468	491	+23

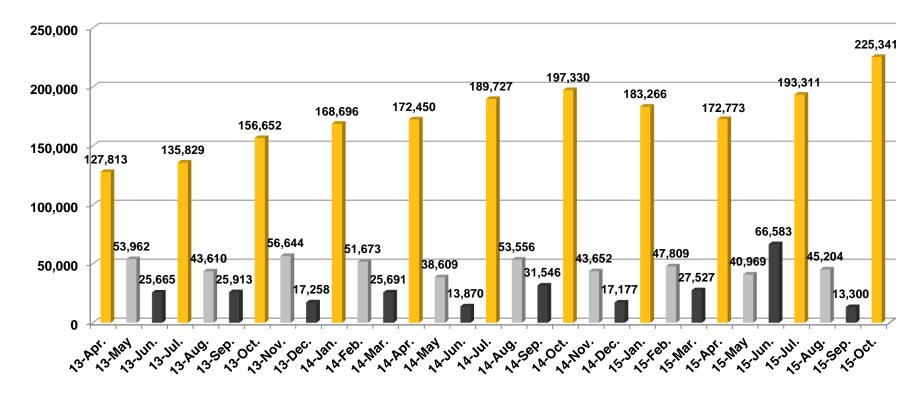


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Quarterly Revenue Pattern

 The quarterly royalty from most of foundries are collected at first month of each quarter and from some other foundries are collected at second month, and none at third month.



Unit : NTD Thousands

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Q3 Revenue Breakdown

Unit: NTD thousands

	Q315	Q215	% change	Q314	% change	2015Q1-Q3	2014Q1-Q3	% change
Licensing	38,167	95,982	-60.24%	61,981	-38.42%	198,205	194,224	2.05%
Royalty	213,648	184,343	15.90%	212,848	0.38%	592,537	551,594	7.42%
Total	251,815	280,325	-10.17%	274,829	-8.37%	790,742	745,818	6.02%

Unit: Number of contracts

		Q315	Q215	2014	2013
Technology	/ Licenses	4	8	21	19
Design	NRE	10	17	82	51
Licenses	Usage	76	87	363	342



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Financial Income Statement

(Unit: NTD thousands)	Q315	Q215	% change	Q314	% change
Revenue	251,815	280,325	-10.17%	274,829	-8.37%
Gross Margin	100%	100%	-	100%	-
Operating Expenses	143,776	141,435	1.66%	135,695	5.96%
Operating Margin	42.9%	49.5%	-6.6ppts	50.6%	-7.7ppts
Net Income	106,301	130,297	-18.42%	124,352	-14.52%
Net Margin	42.2%	46.5%	-4.3ppts	45.2%	-3.0ppts
EPS (Unit: NTD)	1.40	1.72	-18.60%	1.64	-14.63%
ROE	24.5%	30.9%	-6.4ppts	29.7%	-5.2ppts

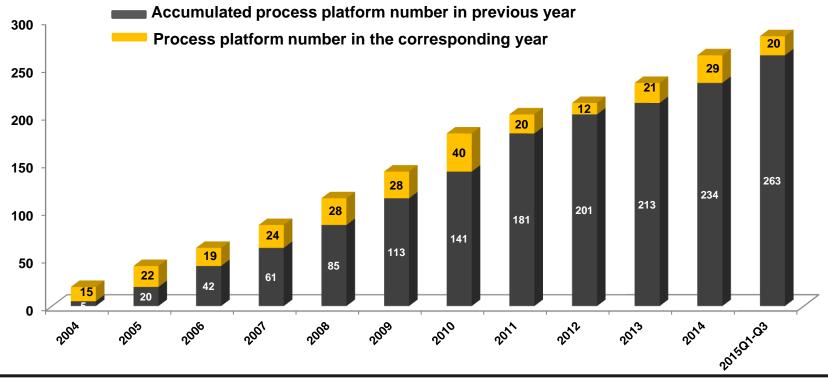


Technology License

Unit: Number of contract

Year	2013	2014	2015Q1-Q3
License number	19	21	17

Note: The terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



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Current Technology Development Platforms

- Total (As of Sep.) : 83*
- 17 for NeoBit, 28 for NeoFuse, 23 for NeoEE, and 15 for NeoMTP.

	14/16nm	28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25 um	Total
NeoBit	-	-	I	-	-	5	11	1	17
NeoFuse	2	6	4	8	2	4	2	-	28
NeoFlash	-	-	-	-	-	-	-	-	-
NeoEE	-	-	2	-	1	6	14	-	23
NeoMTP	-	-	1	1	2	3	8	-	15

Note*: 5 platforms qualified in Q3, 4 platforms kicked off in Q3



Current Technology Development Platforms

12" Fabs	Production	Development	NVM Type	Process Type
16nm	0	2	ОТР	FF+
28nm	4	6	ОТР	LP/HPM, HLP/HPM, LPS
40nm	2	7	OTP, MTP	HV-DDI, LP
55/65nm	10	9	OTP, MTP, Flash	LP, HV-DDI, HV-OLED, DRAM, CIS
80/90nm	5	5	OTP, MTP	HV-DDI, HV-OLED, LP
0.13/0.11um	6	4	OTP, Flash	HV-DDI, BCD, Generic
0.18um	1	0	ОТР	BCD

8" Fabs	Development	NVM Type	Process Type
0.13/0.11um	14	OTP, MTP, Flash	HV-DDI, BCD, LP, RF, CIS, LL
0.18/0.16/0.152um	35	OTP, MTP	Generic, LP, LL, MR, HV, Green, BCD
0.25um	1	OTP, MTP	BCD
0.35um	0	ОТР	UHV

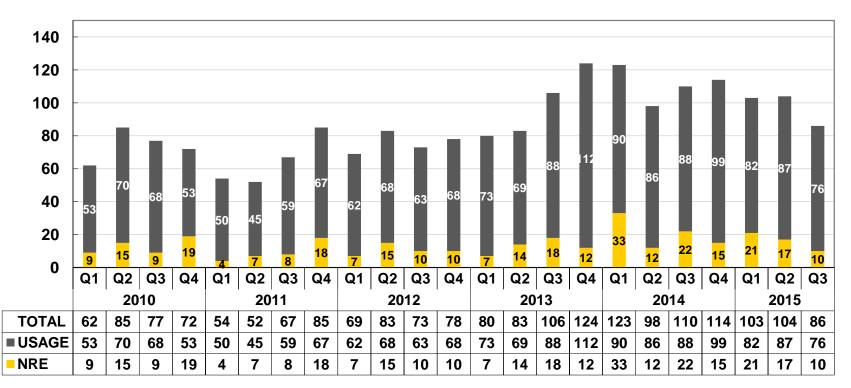
*As of Sep. 30, 2015



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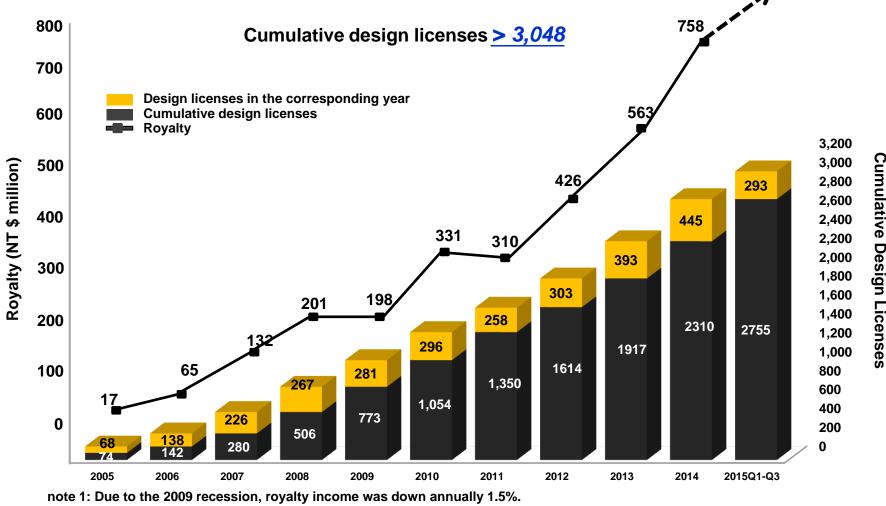
Quarterly Design Licensing (New Tape Out)

- Total 293 NTO as of Q3 2015 (445@2014 393@2013, 303@2012, 258@2011)



Usage : Usage of pre-qualified and verified IP (charged by per product tape out or annual package), the cycle time from design implementation to royalty payments for mass production is faster, typically less than one year. NRE: NRE covers the customization of IP that must undergo new verification or qualification. It typically requires 1 to 1.5 years before resulting in royalty revenue.

Cumulative Licenses Drive Future Royalties

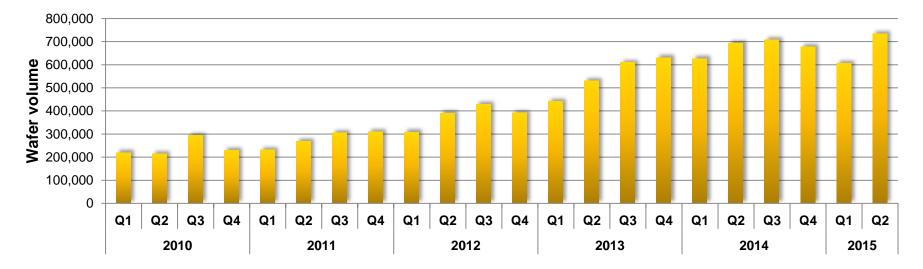


note 2: Pre-payment of royalty fees by a single customer contributed to 2010 annual growth of 67%, causing a drop of 6.3% in the following year, 2011.

note 3: CAGR for 2009-2013 was 30%.

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Wafer Production Volume



embedded eMemory IP in T Company (\$revenue); * % of Process node in T company total revenue in Q315

	Process node	*% of T	Q315	Q215	2014	2013
8"	0.25/0.35	4%	38.2%	34.4%	30.5%	27.3%
	0.15/0.18	12%	7.9%	8.9%	11.9%	10.7%
	0.11/0.13	2%	30.9%	17.0%	20.8%	19.1%
12"	90nm	8%	21.8%	19.2%	16.3%	4.8%
	65nm	11%	0.9%	0.4%	0%	0%
	40/45nm	14%	0%	0%	0%	0%
	28nm	27%	0.02%	0.01%	0%	0%
	16/20nm	21%	0%	0%	0%	0%
8"		19%	16.3%	14.5%	15.6%	14.2%
12"		81%	2.3%	1.8%	1.4%	0.69%
Total		100%	5.0%	4.5%	4.5%	4.1%

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Outline

- Business Model
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eMemory's NVM Technologies

Logic NVM portfolio offers one-stop-shop solution.

- Compatible to any process
- > Robust structure
- > Low process cost

- > Competitive macro sizes
- > Easy integration
- > Easy porting

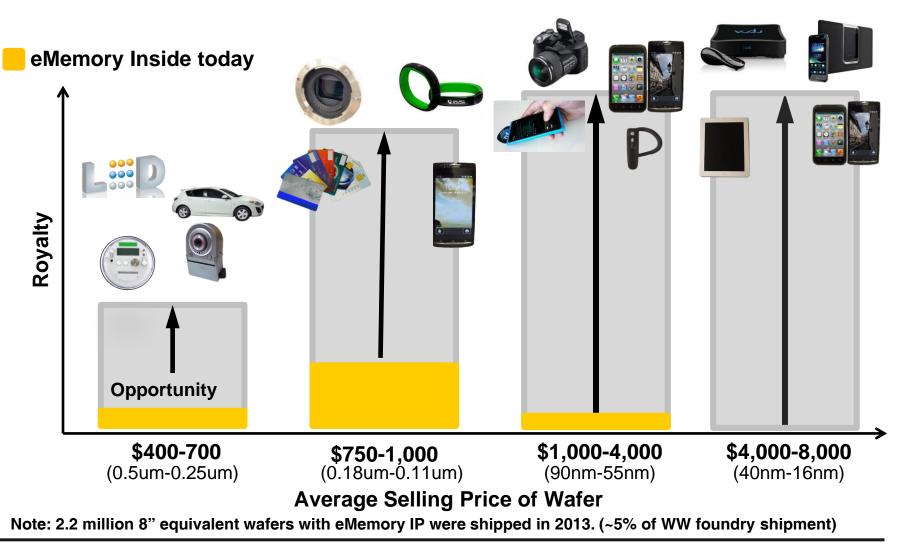
eMemory's NVM	0	ГР	МТР			
Technology	NeoBit	NeoFuse	NeoFlash	NeoEE	NeoMTP	
Product Type	OTP	OTP	Flash	EEPROM	MTP	
Endurance (Cycles)	10	10	1K~10K	10K~100K	1K~10K	
Additional Mask Steps	0	0	2-3	0	0	
Technology	Floating gate	Anti-Fuse	SONOS	Floating gate	Floating gate	
Scalability	Simple	Simple	Simple	Simple	Simple	
Memory Density	HD < 512Kb GHD < 16Mb	< 4Mb	< 2Mb	< 4Kb	< 512Kb	



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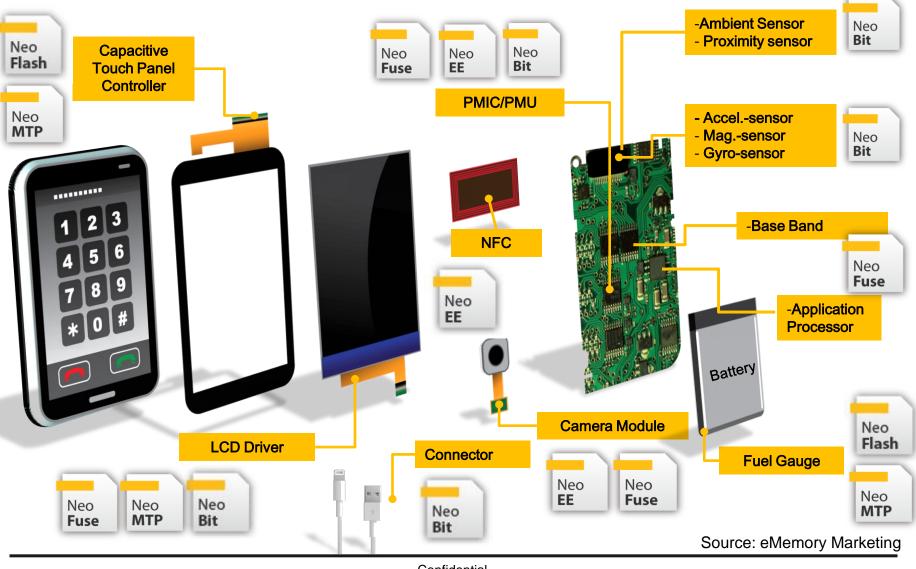
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Opportunity at all Price Points





eMemory IP in Smart Phone

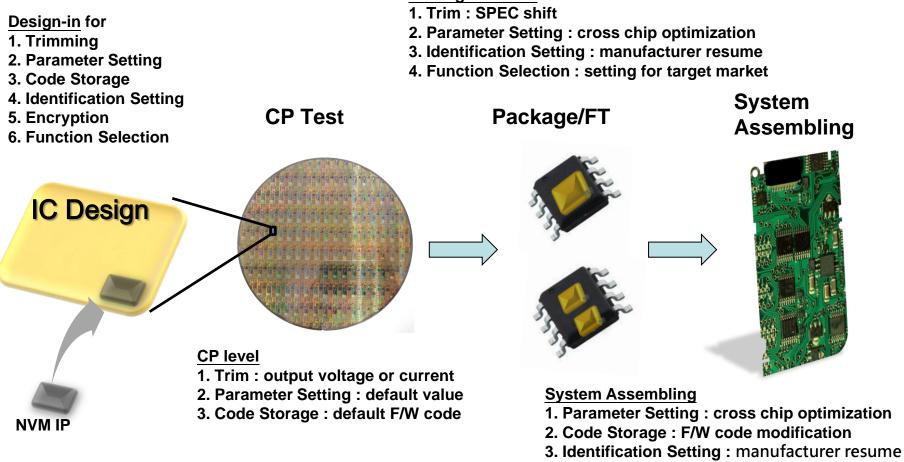


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Benefits from Using eMemory IPs

Package/FT level

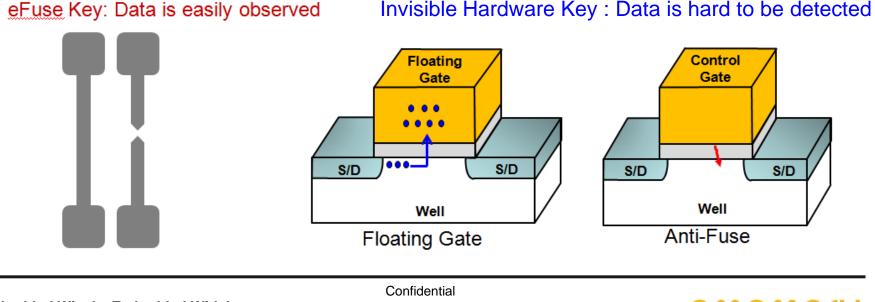


4. Encryption : Security algorithm or key storage

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Invisibility for Security

- Provide "Invisible Hardware Key" for invisible storage
- Prevent reverse-engineering to detect content of security key
- Protect firmware and hardware of ICs from pirating
- Extend & protect customer's business



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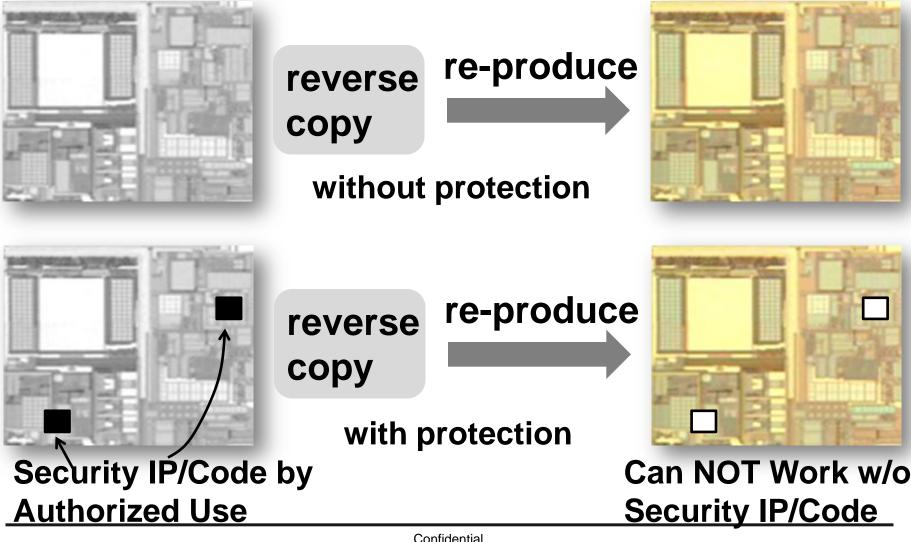
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Security & Protection

Authorized Product

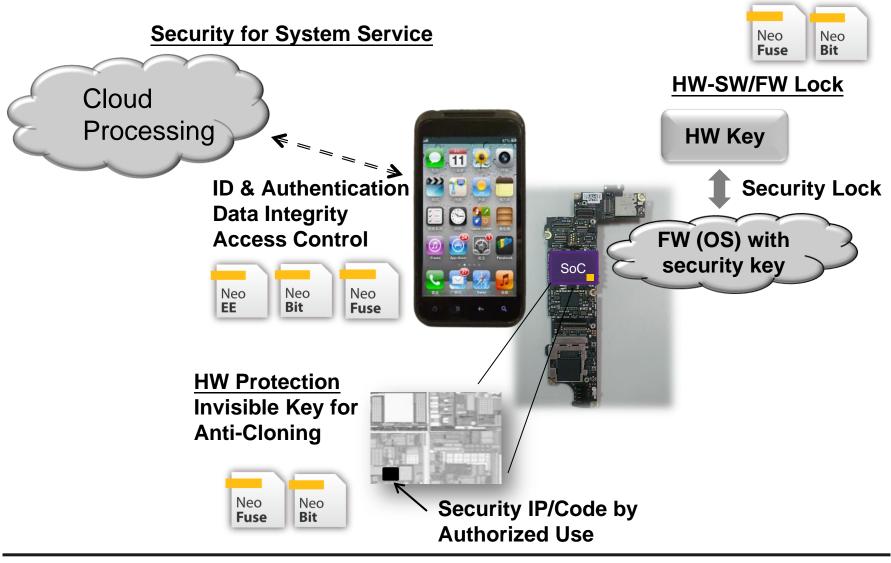




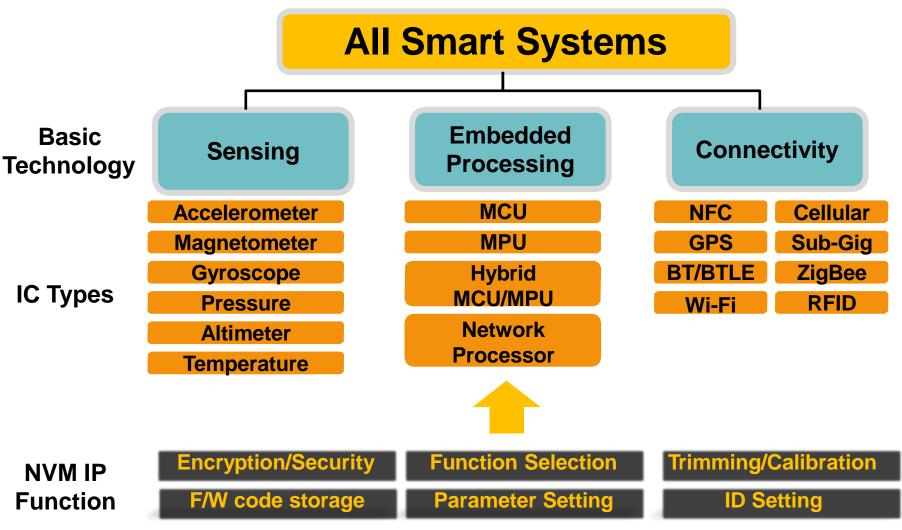
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Security with eMemory IPs



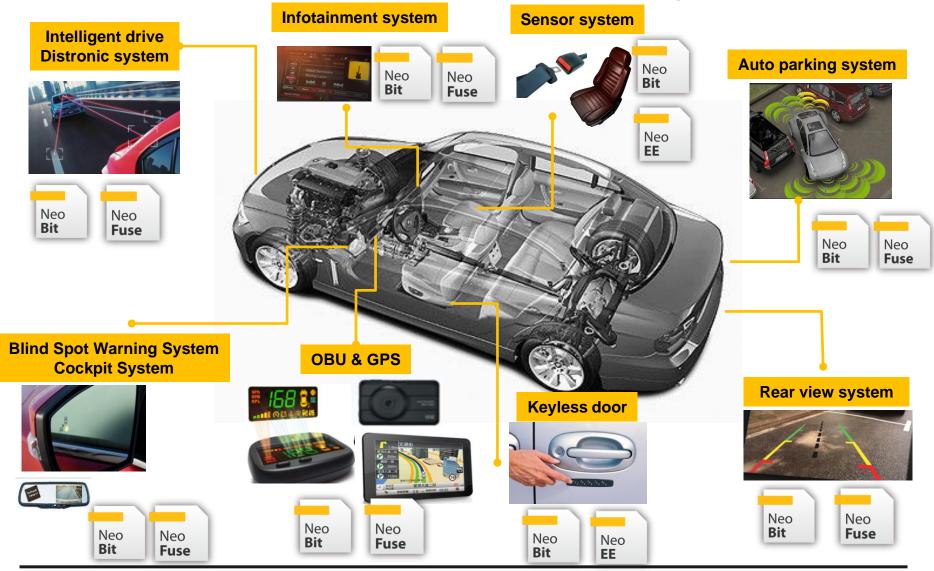
NVM IP Demand in IoT



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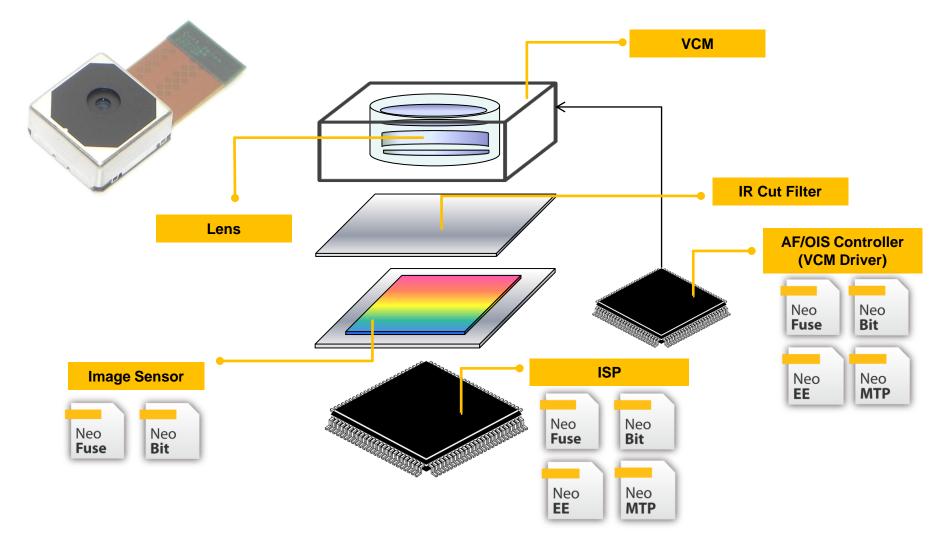
Autotronics with eMemory IPs



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Imager Module with eMemory IPs

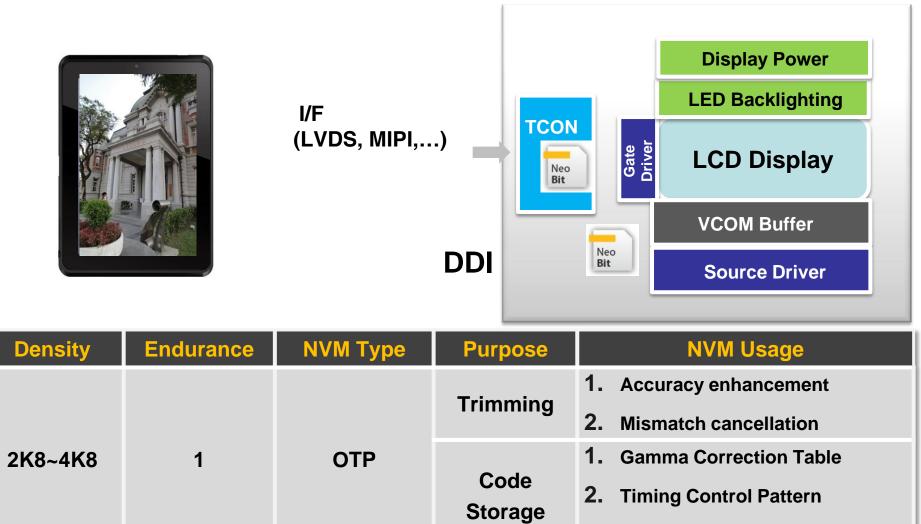


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Advanced LCD Driver ICs

Process Technology : 0.11um HV/80nm HV/55nm HV



3. Color Engine Enhancement

Power Management ICs for Baseband and Application Processor

Process Technology : Advanced 0.25um BCD/ 0.18um BCD/ 0.13um BCD Mature 0.18um/0.16um/0.152um Logic

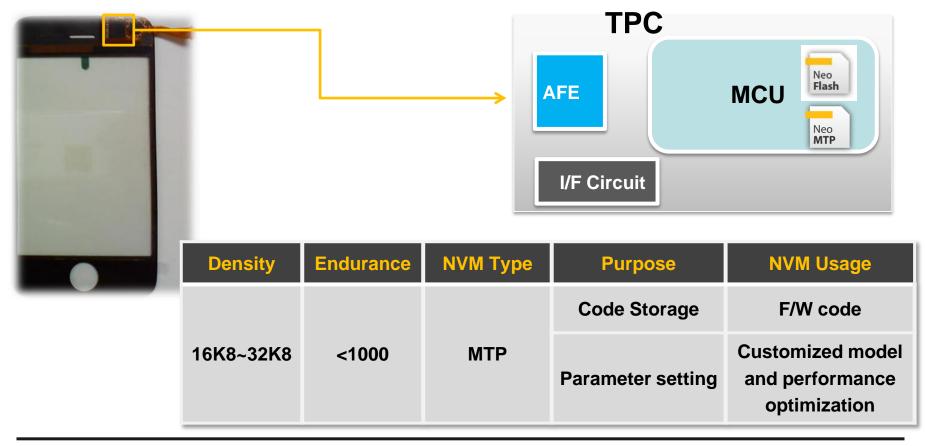
Application Processor	Density	NVM Type	Purpose	NVM Usage
	2Kb~4Kb	ОТР	Trimming	DC/DC, Bandgap
			Parameter Setting	Design flexibility & Performance optimization
			Code Storage	Start-up behavior & smart power saving algorithm
Base Band IC	PMIC	Neo Bit		

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Touch Panel Controller ICs

Process Technology : 0.16um HV/0.11um G

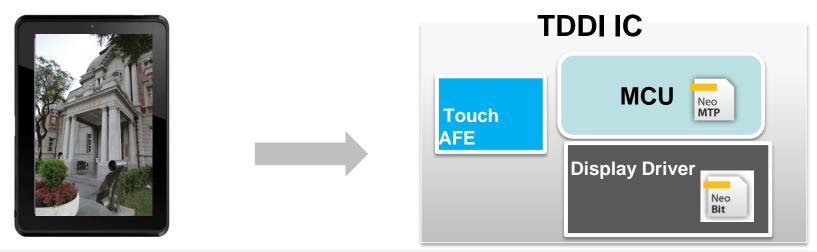


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In-Cell Touch Panel Controllers ICs

Process Technology : 0.11um HV/80nm HV/55nm HV



Density	Endurance	NVM Type	Purpose	NVM Usage
2K8~4K8	1	ОТР	Trimming	Accuracy
			Code Storage	Gamma Table
16K8~32K8	<1000	МТР	Code Storage	Touch F/W Code
			Parameter setting	Performance Optimization

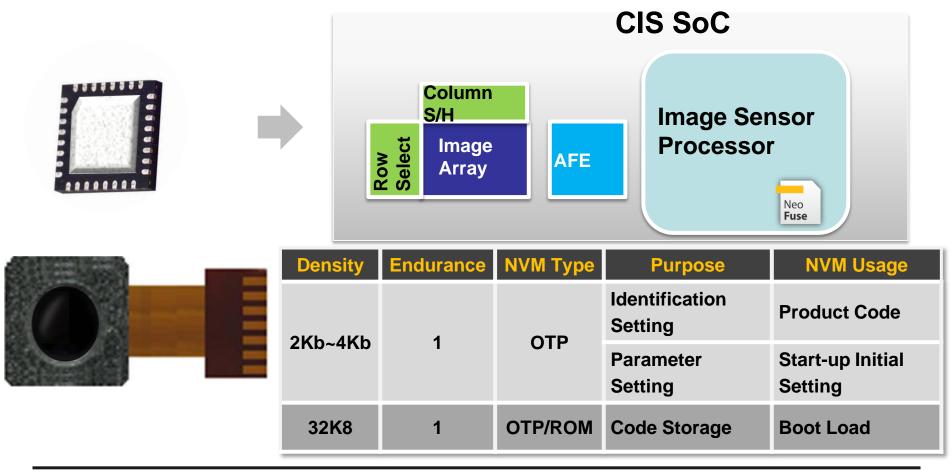
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CMOS Image Sensor

Process Technology : 0.11um CIS/90nm CIS/65nm CIS

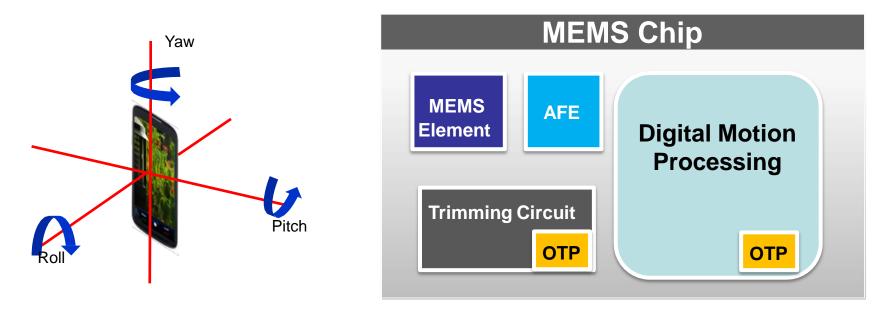


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MEMS 180/160/15x nm HV/Logic for MEMS Controller



Density	NVM Type	Purpose	NVM Usage
2Kb~4Kb	b~4Kb OTP	Trimming	Factory trimming
	Parameter Setting	Signal filtering	
	Code Storage	Geometric computation	

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Replacement of Embedded Flash for Competitiveness Improvement

product design & manufacturing by embedded Flash Logic Process + 10 Masks

30% more cost reduction

wafer cost & testing time

product design & manufacturing by Embedded Logic NVM (OTP/MTP) Logic Process

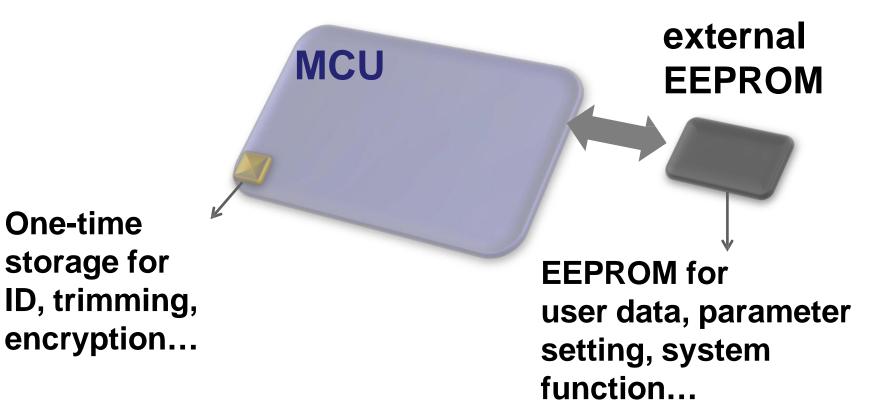
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MCU

MCU

MCU Applications with EEPROM



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One-time



NeoBit + NeoEE

Hybrid NVM solution (NeoBit + NeoEE) with customized SPEC & optimized size



One single IP by integration of NeoBit & NeoEE Help for system size reduction

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Wafer Demand by IC Type

ІС Туре	Equ. to 8-inch wafer (K)		
AP	4964		
PMU	4756		
CIS sensor	4226		
Fingerprint	4000		
Smart card controller	3000		
Base Band	2935		
LCD driver (with TCON)	2013		
Gauge IC	627		
Touch panel controller (C)	556		
Connectivity	395		
STB controller	335		
TV controller	327		
Wifi controller	245		
LED driver	243		
DC-DC/AC-DC	176		
Accelerator sensor controller	124		
Light snesor	121		
Bluetooth controller	121		
Gyroscope sensor controller	104		
TAG IC	76		
DVD controller	67		
MCU (8bits, LV/3.3V)	56		
MCU (8bits, LV/3.3V)	56		
P-Gamma	52		
MCU (8bits, pure 5V)	51		
NB CAM controller	42		
Pressure sensor controller	20		
Touch pad controller	18		
PC CAM controller	15		
Touch panel controller (R)	5		
TCON (w/o driver)	4		

2014.8.29 updated



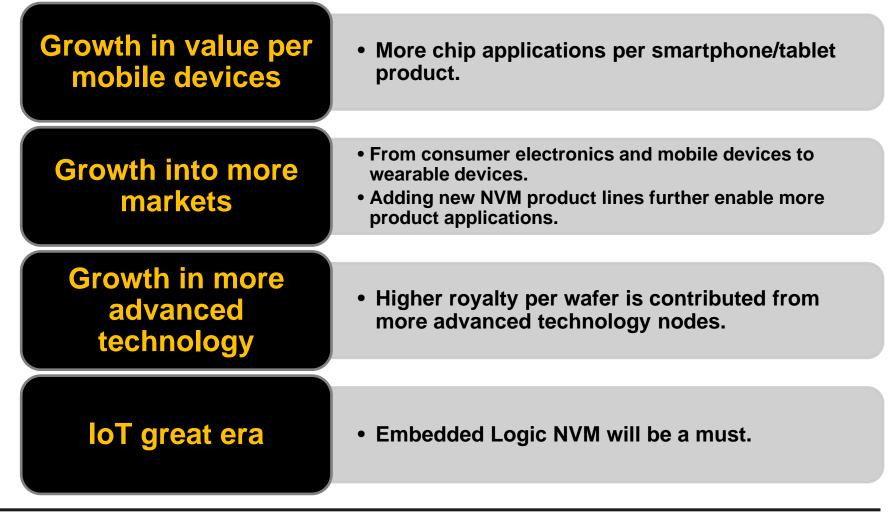
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Outlook for 3Q and Beyond

- Applications in major smart phone customer continue their momentum and expand to wearable devices.
- PMICs in Chinese smart phone continue to increase production and expand to new power management applications, such as fast charger and wireless charger.
- TDDI and 55nm LCD Drivers start to ramp up.
- Applications in STB, Fingerprints, and CIS will ramp up in 2H of 2015.
- Due to security requirement and yield issue, replacement of efuse by NeoFuse is accelerating in the advanced process nodes.
- Co-work with leading foundry and European auto-electronic customers to provide automotive grade IP.



Key Growth Drivers





Q & A



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